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SFF Committee

SFF-8419

Specification for

SFP+ Power and Low Speed Interface

Rev 1.3 June 11, 2015

Secretariat: SFF Committee

Abstract: This specification defines the low speed electrical and management interface specifications for SFP+ (enhanced Small Formfactor Pluggable) modules and hosts. The SFP+ module is a hot pluggable small footprint serial-to-serial data-agnostic optical transceiver.

This specification provides a common reference for systems manufacturers, system integrators, and suppliers. This is an internal working specification of the SFF Committee, an industry ad hoc group.

This specification is made available for public review, and written comments are solicited from readers. Comments received by the members will be considered for inclusion in future revisions of this specification.

Support: This specification is supported by the identified member companies of the SFF Committee.

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EXPRESSION OF SUPPORT BY MANUFACTURERS

The following member companies of the SFF Committee voted in favor of this industry specification:

Amphenol	JDS Uniphase
Arista	QLogic
Broadcom	Shinning Electronics
Finisar	Sichuan
GLGnet Electronics	Sumitomo
Hewlett Packard	TE Connectivity
HGST	

The following member companies of the SFF Committee voted against this industry specification.

Foxconn	Mellanox
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The following member companies of the SFF Committee voted to abstain on this industry specification.

EMC	Seagate
FCI	

The user's attention is called to the possibility that implementation to this Specification may require use of an invention covered by patent rights. By distribution of this specification, no position is taken with respect to the validity of a claim or claims or of any patent rights in connection therewith. Members of the SFF Committee which advise that a patent exists are required to provide a statement of willingness to grant a license under these rights on reasonable and non-discriminatory terms and conditions to applicants desiring to obtain such a license.

Change History:

Rev 1.0 March 31, 2015

- Content derived from SFF-8431 Rev 4.2 Sections 2.1-2.7 and 4
- Updated with current template, but modified numbering to retain Section 2 as the beginning of technical content as per SFF-8431 and retained sequential Table/Figure numbering instead of within section.
- Converted symbols to text and editorial corrections made to case, consistency of expression, etc.
- Corrected references to SFF-8083 to be SFF-8071

Rev 1.1 May 8, 2015

- Added cross-references to SFF-8431 sections/tables/figures

Rev 1.2 May 29, 2015

- Corrected references to SFP+ Module Power Supply Requirements in Section 2.6.

Rev 1.3 June 3, 2015

- Transferred power supply Section 2 and Appendix D.17 from SFF-8418
- Title changed to reflect the transferred content

Foreword

The development work on this specification was done by the SFF Committee, an industry group. The membership of the committee since its formation in August 1990 has included a mix of companies which are leaders across the industry.

When 2 1/2" diameter disk drives were introduced, there was no commonality on external dimensions e.g. physical size, mounting locations, connector type, connector location, between vendors.

The first use of these disk drives was in specific applications such as laptop portable computers and system integrators worked individually with vendors to develop the packaging. The result was wide diversity, and incompatibility.

The problems faced by integrators, device suppliers, and component suppliers led to the formation of the SFF Committee as an industry ad hoc group to address the marketing and engineering considerations of the emerging new technology.

During the development of the form factor definitions, other activities were suggested because participants in the SFF Committee faced more problems than the physical form factors of disk drives. In November 1992, the charter was expanded to address any issues of general interest and concern to the storage industry. The SFF Committee became a forum for resolving industry issues that are either not addressed by the standards process or need an immediate solution.

Those companies which have agreed to support a specification are identified in the first pages of each SFF Specification. Industry consensus is not an essential requirement to publish an SFF Specification because it is recognized that in an emerging product area, there is room for more than one approach. By making the documentation on competing proposals available, an integrator can examine the alternatives available and select the product that is felt to be most suitable.

SFF Committee meetings are held during T10 weeks (see www.t10.org), and Specific Subject Working Groups are held at the convenience of the participants. Material presented at SFF Committee meetings becomes public domain, and there are no restrictions on the open mailing of material presented at committee meetings.

Most of the specifications developed by the SFF Committee have either been incorporated into standards or adopted as standards by EIA (Electronic Industries Association), ANSI (American National Standards Institute) and IEC (International Electrotechnical Commission).

If you are interested in participating or wish to follow the activities of the SFF Committee, the signup for membership and/or documentation can be found at:
www.sffcommittee.com/ie/join.html

The complete list of SFF Specifications which have been completed or are currently being worked on by the SFF Committee can be found at:
<ftp://ftp.seagate.com/sff/SFF-8000.TXT>

If you wish to know more about the SFF Committee, the principles which guide the activities can be found at:
<ftp://ftp.seagate.com/sff/SFF-8032.TXT>

Suggestions for improvement of this specification will be welcome. They should be sent to the SFF Committee, 14426 Black Walnut Ct, Saratoga, CA 95070.

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SFP+ Power and Low Speed Interface**1. Scope**

This specification defines the low speed electrical and management interface specifications for SFP+ (enhanced Small Formfactor Pluggable) modules and hosts. The SFP+ module could be an electrical-to-optical or an electrical-to-electrical device.

1.1 References**1.1.1 Industry Documents**

The following interface standards are relevant to many SFF Specifications.

INF-8074i	SFP (Small Formfactor Pluggable) 1 Gb/s Transceiver
INF-8077i	XFP 10 Gb/s 1X Pluggable Module
SFF-8071	SFP+ 1X 0.8mm Card Edge Connector
SFF-8083	SFP+ 1X 10 Gb/s Pluggable Transceiver Solution (SFP10)
SFF-8079	SFP Rate and Application Selection
SFF-8089	SFP Rate and Application Codes
SFF-8418	SFP+ 10 Gb/s Electrical Interface
SFF-8431	SFP+ 10 Gb/s and Low Speed Electrical Interface
SFF-8432	SFP+ 10 Gb/s Module and Cage
SFF-8472	Management Interface for SFP+

1.1.2 SFF Specifications

There are several projects active within the SFF Committee. The complete list of specifications which have been completed or are still being worked on are listed in the specification at <ftp://ftp.seagate.com/sff/SFF-8000.TXT>

1.1.3 Sources

Those who join the SFF Committee as an Observer or Member receive electronic copies of the minutes and SFF specifications (<http://www.sffcommittee.com/ie/join.html>).

Copies of ANSI standards may be purchased from the InterNational Committee for Information Technology Standards (<http://www.techstreet.com/incitsgate.tmpl>).

1.1.4 Conventions

The dimensioning conventions are described in ANSI-Y14.5M, Geometric Dimensioning and Tolerancing. All dimensions are in millimeters, which are the controlling dimensional units (if inches are supplied, they are for guidance only).

The ISO convention of numbering is used i.e., the thousands and higher multiples are separated by a space and a period is used as the decimal point. This is equivalent to the English/American convention of a comma and a period.

American	French	ISO
0.6	0,6	0.6
1,000	1 000	1 000
1,323,462.9	1 323 462,9	1 323 462.9

2. Power Requirements

The module host has two 3.3 V power contacts, one supplying the module transmitter voltage (VccT) and the other supplying the module receiver voltage (VccR). The maximum current capacity, both continuous and peak, for each connector contact is 500 mA.

SFP+ module maximum power consumption shall meet one of the following power classes:

- Power Level I modules - Up to 1.0 W
- Power Level II modules - Up to 1.5 W
- Power Level III modules - Up to 2.0 W

To avoid exceeding system power supply limits and cooling capacity, all modules at power up by default shall operate with up to 1.0 W. Hosts supporting Power Level II or III operation may enable a Power Level II or III module through the 2-wire interface. Power Level II or III modules shall assert the power level declaration bit of SFF-8472.

The maximum power level is allowed to exceed the classified power level for 500 ms following hot insertion or power up, or Power Level II or III authorization, however the current is limited to values given by Table 1 and illustrated in Figure 1.

At host power up the host shall supply VccT and VccR to the module within 100 ms of each other.

2.1.1 Module Power Supply Requirements

SFP+ module operates from the host supplied VccT and VccR. To protect the host and system operation, each SFP+ module during hot plug and normal operation shall follow the requirements listed in Table 1 and illustrated by Figure 1. The requirements for current apply to the current through each inductor of Figure 20 while the power supply voltages are defined at the SFP+ connector.

2.1.2 Host Power Supply Noise Output

The host shall generate an effective weighted integrated spectrum RMS noise less than 25 mV in the frequency range 10 Hz to 10 MHz, according to the methods of A.1.1.

2.1.3 Module Power Supply Noise Output

The module shall generate less than 15 mV RMS noise at point X of Figure 20 in the frequency range 10Hz to 10MHz, according to the methods of A.1.2.

2.1.4 Power Supply Noise Tolerance

SFP+ modules shall meet all electrical requirements and remain fully operational in the presence of a sinusoidal tolerance signal of amplitude given by Table 1 swept from 10 Hz to 10 MHz according to the methods of A.1.3. This emulates the worst case noise of the host.

It is also desirable for a module and host to each tolerate a degree of random or semi-random noise on both VccT and VccR simultaneously, but the characteristics of this noise are beyond the scope of this document.

TABLE 1 SFP+ MODULE POWER SUPPLY REQUIREMENTS

Parameters	Symbol	Condition	Min	Max	Unit
Common Parameters					
Power supply noise tolerance including ripple [peak-to-peak]		see A.1.3		66	mV
Power supply voltages including ripple, droop and noise below 100 kHz	VccT, VccR	*1	3.14	3.46	V
Instantaneous peak current at hot plug		*2 *3		400	mA
Sustained peak current at hot plug		*2 *3 *5		330	mA
Power Level I Module					
Module maximum power consumption				1.0	W
Power Level II Module					
Instantaneous peak current on enabling Power Level II		*2 *3 *5		600	mA
Module sustained peak current on enabling Power Level II		*2 *3 *5		500	mA
Maximum power consumption at power up		*4		1.0	W
Module maximum power consumption				1.5	W
Power Level III Module					
Instantaneous peak current on enabling Power Level III		*2 *3 *5		800	mA
Module sustained peak current on enabling Power Level III		*2 *3 *5		660	mA
Maximum power consumption at power up		*4		1.0	W
Module maximum power consumption				2.0	W
<p>*1 Set point is measured at the input to the connector on the host board reference to Vee. Droop is any temporary drop in voltage of the power supply such as that caused by plugging in another module or when enabling another module to Power Level II.</p> <p>*2 The requirements for current apply to the current through each inductor of Figure 20.</p> <p>*3 The maximum currents are the allowed currents for each power supply VccT or VccR, therefore the total module peak currents can be twice this value. The instantaneous peak current is allowed to exceed the specified maximum current capacity of the connector contact for a short period, see Figure 1.</p> <p>*4 Maximum module power consumption shall not exceed 1.0 W from 500ms after power up until level II operation is enabled.</p> <p>*5 Not to exceed the sustained peak limit for more than 50 us; may exceed this limit for shorter durations.</p>					

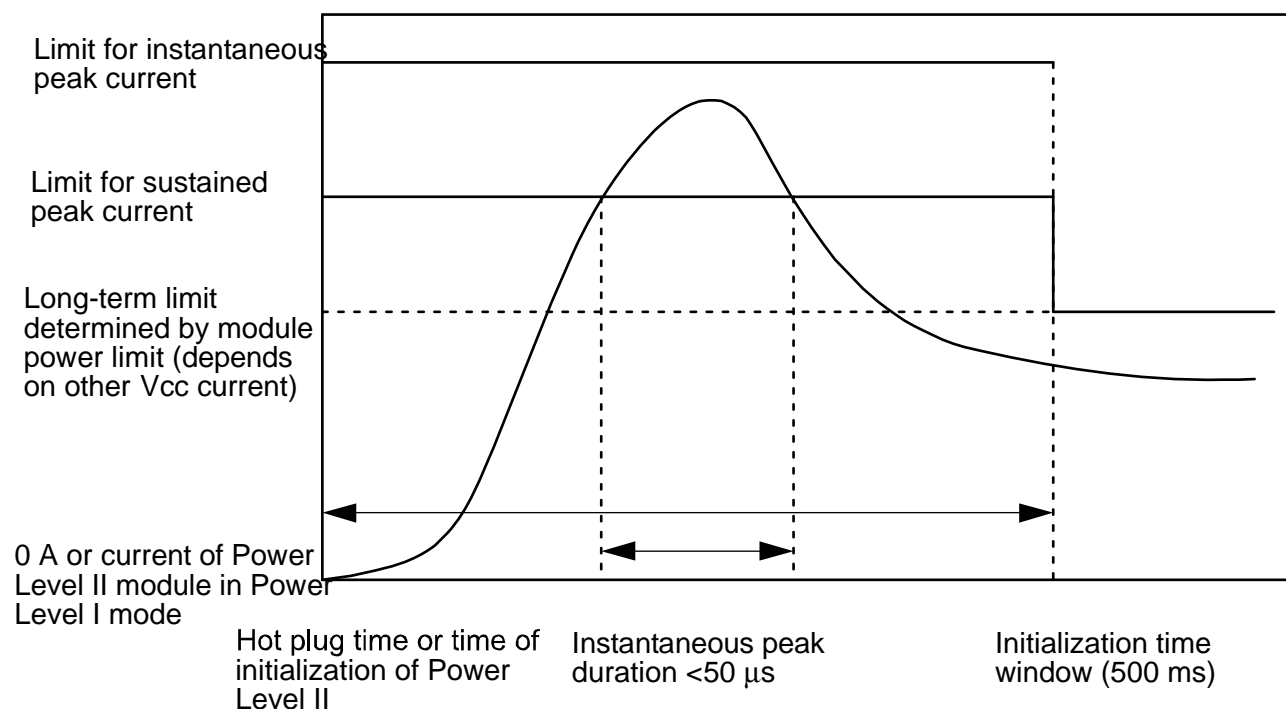


FIGURE 1 INSTANTANEOUS AND SUSTAINED PEAK CURRENT FOR VCCT OR VCCR

2.2 ESD

The SFP+ module and host SFI contacts (High Speed Contacts) shall withstand 1000 V electrostatic discharge based on Human Body Model per JEDEC JESD22-A114-B. The SFP+ module and all host contacts with exception of the SFI contacts (High Speed Contacts) shall withstand 2 kV electrostatic discharge based on Human Body Model per JEDEC JESD22-A114-B.

The SFP+ module shall meet ESD requirements given in EN61000-4-2, criterion B test specification such that units are subjected to 15 kV air discharges during operation and 8 kV direct contact discharges to the case.

3. Low Speed Interface

3.1 Introduction

This specification has several enhancements over the classic SFP interface (INF-8074i), but the SFP+ host can be designed to also support most legacy SFP modules. SFP+ 2-wire interface electrical and timing specifications are defined in Section 5, and the SFP+ 2-wire interface management and register map are defined by SFF-8472.

3.2 Host Connector Definition

The SFP+ host connector is a 0.8 mm pitch 20 position improved connector specified by SFF-8071, or stacked connector with equivalent electrical performance. Host PCB contact assignment is shown in Figure 2 and contact definitions are given in Table 2. SFP+ module contacts mate with the host in the order of ground, power, followed by signal as illustrated by Figure 3 and the contact sequence order listed in Table 2.

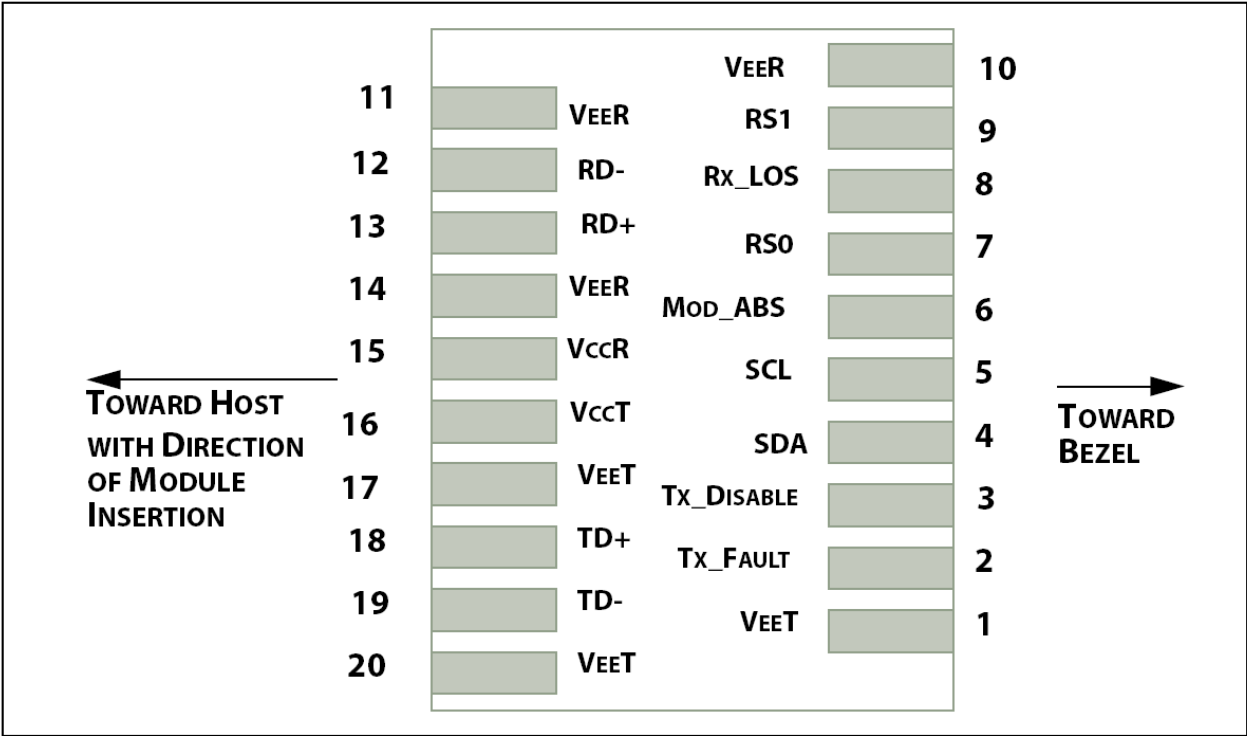


FIGURE 2 HOST PCB SFP+ PAD ASSIGNMENT TOP VIEW

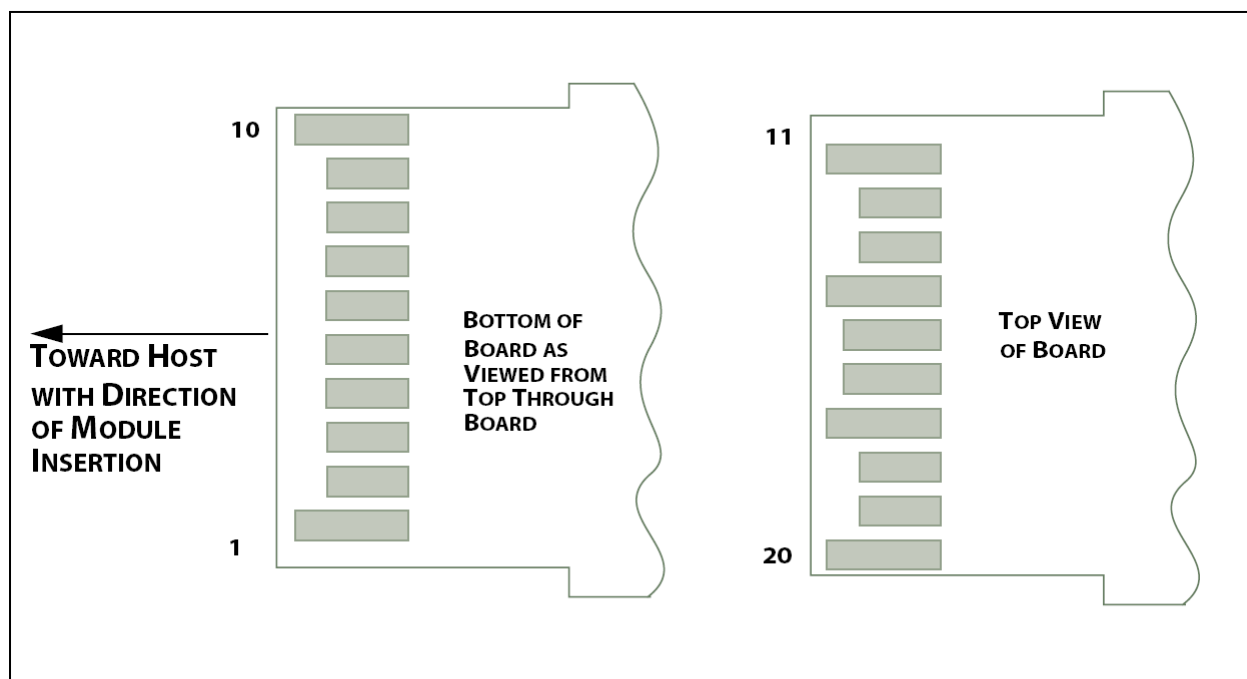
**FIGURE 3 SFP+ MODULE CONTACT ASSIGNMENT**

TABLE 2 SFP+ MODULE AND HOST ELECTRICAL CONTACT DEFINITION

Contacts	Logic 1 *1	Symbol	Power Sequence Order	Name/Description	Note
case		case	*2	Module case	
1		VeeT	1st	Module Transmitter Ground	*3
2	LVTTL-0	Tx_Fault	3rd	Module Transmitter Fault	*4
3	LVTTL-I	Tx_Disable	3rd	Transmitter Disable; Turns off transmitter laser output	*5
4	LVTTL-I/O	SDA	3rd	2-wire Serial Interface Data Line (Same as MOD-DEF2 in INF-8074i)	*6
5	LVTTL-I/O	SCL	3rd	2-wire Serial Interface Clock (Same as MOD-DEF1 in INF-8074i)	*6
6		Mod_ABS	3rd	Module Absent, connected to VeeT or VeeR in the module	*7
7	LVTTL-I	RS0	3rd	Rate Select 0, optionally controls SFP+ module receiver.	*8
8	LVTTL-0	Rx_LOS	3rd	Receiver Loss of Signal Indication (In FC designated as Rx_LOS and in Ethernet designated as Signal Detect)	*4
9	LVTTL-I	RS1	3rd	Rate Select 1, optionally controls SFP+ module transmitter	*8
10		VeeR	1st	Module Receiver Ground	*3
11		VeeR	1st	Module Receiver Ground	*3
12	CML-0	RD-	3rd	Receiver Inverted Data Output	
13	CML-0	RD+	3rd	Receiver Non-Inverted Data Output	
14		VeeR	1st	Module Receiver Ground	*3
15		VccR	2nd	Module Receiver 3.3 V Supply	
16		VccT	2nd	Module Transmitter 3.3 V Supply	
17		VeeT	1st	Module Transmitter Ground	*3
18	CML-I	TD+	3rd	Transmitter Non-Inverted Data Input	
19	CML-I	TD-	3rd	Transmitter Inverted Data Input	
20		VeeT	1st	Module Transmitter Ground	*3

*1 Labeling as inputs (I) and outputs (O) are from the perspective of the module

*2 The case makes electrical contact to the cage before any of the board edge contacts are made.

*3 The module signal ground contacts, VeeR and VeeT, should be isolated from the module case.

*4 This contact is an open collector/drain output contact and shall be pulled up on the host see 4.1.1 and 4.1.6. Pull ups can be connected to one of several power supplies, however the host board design shall ensure that no module contact has voltage exceeding module VccT/R + 0.5 V.

*5 Tx_Disable is an input contact with a 4.7 kOhms to 10 kOhms pullup to VccT inside the module.

*6 See 5.2

*7 See 4.1.4

*8 For SFF-8431 rate select definition see 4.1.3 and 4.2. (If implementing SFF-8079 contacts 7 and 9 in SFF-8431 are used for AS0 and AS1 respectively).

4. Low Speed Electrical Control Contacts and 2-Wire Interface

In addition to the 2-wire serial interface, the SFP+ module has the following low speed contacts for control and status:

- Tx_Fault
- Tx_Disable
- RS0/RS1
- Mod_ABS
- Rx_LOS

4.1.1 Tx_Fault

Tx_Fault is a module output that when high, indicates that the module transmitter has detected a fault condition related to laser operation or safety. If Tx_Fault is not implemented, the Tx_Fault contact signal shall be held low by the module and may be connected to Vee within the module.

The Tx_Fault output is an open drain/collector and shall be pulled up to the Vcc_Host in the host with a resistor in the range 4.7 kOhms to 10 kOhms, or with an active termination according to Table 5.

4.1.2 Tx_Disable

When Tx_Disable is asserted high or left open, the SFP+ module transmitter output shall be turned off unless the module is a passive cable assembly (see Appendix E in SFF-8418) in which case this signal may be ignored. This contact shall be pulled up to VccT with a 4.7 kOhms to 10 kOhms resistor in modules and cable assemblies. Tx_Disable is a module input contact.

When Tx_Disable is asserted low or grounded the module transmitter is operating normally.

4.1.3 RS0/RS1

RS0 and RS1 are module inputs and are pulled low to VeeT with >30 kOhms resistors in the module. RS0 optionally selects the optical receive signaling rate coverage. RS1 optionally selects the optical transmit signaling rate coverage. For logical definitions of RS0/RS1 see Section 4.2.

These contacts can also be used for AS0 and AS1 if implementing SFF-8079. See SFF-8079 for details.

RS1 is commonly connected to VeeT or VeeR in the classic SFP modules. The host needs to ensure that it will not be damaged if this contact is connected to VeeT or VeeR in the module.

4.1.4 Mod_ABS

Mod_ABS is connected to VeeT or VeeR in the SFP+ module. The host may pull this contact up to Vcc_Host with a resistor in the range 4.7 kOhms to 10 kOhms. Mod_ABS is asserted 'High' when the SFP+ module is physically absent from a host slot. In the SFP MSA (INF-8074i) this contact has the same function but is called MOD_DEF0.

4.1.5 SCL/SDA

SCL is the 2-wire interface clock and SDA is the 2-wire interface data line. SCL and SDA are pulled up to Vcc_Host_2w by resistors in the host. For full specifications see Section 5.

4.1.6 Rx_LOS

Rx_LOS when high indicates an optical signal level below that specified in the relevant standard. Rx_LOS is an open drain/collector output, but may also be used

as an input by supervisory circuitry in the module. For a nominally 3.3 V Vcc_Host using a resistive pull up to Vcc_Host the resistor value shall be in the range 4.7 kOhms to 10 kOhms. For a nominally 2.5 V Vcc_Host using a resistive pull up to Vcc_Host the resistor value shall be in the range 4.7 kOhms to 7.2 kOhms. Alternatively, an active termination according to Table 5 may be used.

The Rx_LOS signal is intended as a preliminary indication to the host in which the module is installed that the received signal strength is below the specified range. Such an indication typically points to non-installed cables, broken cables, or a disabled, failing or a powered off transmitter at the far end of the cable. Additional indications are provided by the host in which the module is installed to verify that the information being transmitted is valid, correctly encoded, and in the correct format. Such additional indications are outside the scope of the module specification.

Rx_LOS may be an optional function depending on the supported standard. If the Rx_LOS function is not implemented, or is reported via the two-wire interface only, the Rx_LOS contact shall be held low by the module and may be connected to Vee within the module.

Rx_LOS assert min and de-assert max are defined in the relevant standard. To avoid spurious transition of Rx_LOS a minimum hysteresis of 0.5 dBo is recommended.

4.2 Rate Select Hardware Control

The SFP+ module provides two inputs RS0 and RS1 that can optionally be used for rate selection. RS0 controls the receive path signalling rate capability, and RS1 controls the transmit path signalling rate capability, as defined in Table 3. The host and module may choose to use either, both, or none of these functions. Because contact 9 in the classic SFP INF-8074i is connected to VeeR, an SFP+ host utilizing RS1 must provide short circuit protection.

This rate select functionality can also be controlled by software as defined by SFF-8472.

Optionally the rate select methods of Part 2 of SFF-8079 may be used instead of the method described here by setting the management declaration bit (A0h byte 93 bit 2) to 1, see SFF-8472.

TABLE 3 RATE SELECT HARDWARE CONTROL CONTACTS

Parameter	State	Conditions
RS0	Low	RX signalling rate less than or equal to 4.25 GBd
	High	RX signalling rate greater than 4.25 GBd
RS1	Low	TX signalling rate less than or equal to 4.25 GBd
	High	TX signalling rate greater than 4.25 GBd

4.3 Low Speed Electrical Specifications

SFP+ low speed signalling is based on Low Voltage TTL (LVTTTL) operating with a module supply of 3.3 V +/-5% and with a host supply range of 2.38 to 3.46 V.

The 2-wire interface protocol and electrical specifications are defined in Section 5.

4.3.1 Module Low Speed Electrical Specifications

The SFP+ module low speed electrical specifications are given in Table 4. All I/O powered by VccT is referenced to VeeT and similarly VccR is referenced to VeeR.

TABLE 4 LOW SPEED MODULE ELECTRICAL SPECIFICATIONS

Parameter	Symbol	Min	Max	Unit	Conditions
Module Vcc	VccT, VccR	3.14	3.46	V	
Tx_Fault, Rx_LOS	VOL	-0.3	0.40	V	At 0.7 mA *
	IOH 1	-50	37.5	uA	Measured with a 4.7 kOhms load pulled up to Vcc_Host where Vcc_Host_min<Vcc_host<Vcc_Host_max
Tx_Disable , RS0, RS1	VIL	-0.3	0.80	V	
	VIH	2.0	VccT + 0.3	V	

* Positive values indicate current flowing into the module.

4.3.2 Host Low speed Electrical Specifications

The SFP+ Host low speed electrical specifications are given in Table 5. All I/O powered by VccT is referenced to VeeT and similarly VccR is referenced to VeeR.

TABLE 5 LOW SPEED HOST ELECTRICAL SPECIFICATIONS

Parameter	Symbol	Min	Max	Unit	Conditions
Host Vcc Pullup	Vcc_Host	2.38	3.46	V	
Tx_Fault, Rx_LOS	VIL	*	*	V	
	VIH	*	*	V	
Tx_Disable	VOL	-0.3	0.4	V	VOL measured with 4.7 kOhms to 10 kOhms pull up to VccT max
	VOH	VccT -0.5	VccT + 0.3	V	VOH measured with 10 kOhms pull up to VccT min
	VOL	-0.3	0.4	V	VOL measured with no load
RS0, RS1	VOH	2.2	VccT + 0.3	V	VOH measured with 30 kOhms to VeeR.

* Determined by host design, such that VIH > 2.1 V for the range of IOH in Table 4. One option is using standard LVTTTL input with a pull-up to Vcc_Host in the range 4.7 kOhms to 10 kOhms

4.4 Timing Requirement of Control and Status I/O

The timing requirements of control and status I/O are defined in Table 6, and are applicable to a power supply meeting the SFP+ Module Power Supply Requirements defined in SFF-8418.

TABLE 6 TIMING PARAMETERS FOR SFP+ MANAGEMENT

Parameter	Symbol	Min	Max	Unit	Conditions
Tx_Disable assert time	t_off		100	us	Rising edge of Tx_Disable to fall of output signal below 10% of nominal
Tx_Disable negate time	t_on		2	ms	Falling edge of Tx_Disable to rise of output signal above 90% of nominal. This only applies in normal operation, not during start up or fault recovery.
Time to initialize 2-wire interface	t_2w_start_up		300	ms	From power on or hot plug.
Time to initialize	t_start_up		300	ms	From power on or hot plug or Tx disable negated during power up,

					or Tx_Fault recovery, until non-cooled power level I part (or non-cooled power level II part already enabled at power level II for Tx_Fault recovery) is fully operational.
Time to initialize cooled module and time to power up a cooled module to Power Level II	t_start_up_cooled		90	s	From power on or hot plug, or Tx disable negated during power up or Tx_Fault recovery, until cooled power level I part (or cooled power level II part during fault recovery) is fully operational. Also, from stop bit low-to-high SDA transition enabling Power Level II until cooled module is fully operational
Time to Power Up to Level II	t_power_level2		300	ms	From stop bit low-to-high SDA transition enabling power level II until non-cooled module is fully operational
Time to Power Down from Level II	t_power_down		300	ms	From stop bit low-to-high SDA transition disabling power level II until module is within power level I requirements
Tx_Fault assert	Tx_Fault_on		1	ms	From occurrence of fault to assertion of Tx_Fault
Tx_Fault assert for cooled module	Tx_Fault_on_cooled		50	ms	From occurrence of fault to assertion of Tx_Fault
Tx_Fault Reset	t_reset	10		us	Time Tx_Disable must be held high to reset Tx_Fault
RS0, RS1 rate select timing for FC	t_RS0_FC, t_RS1_FC		500	us	From assertion till stable output
RS0, RS1 rate select timing non FC	t_RS0, t_RS1		24	ms	From assertion till stable output
Rx_LOS assert delay	t_los_on		100	us	From occurrence of loss of signal to assertion of Rx_LOS
Rx_LOS negate delay	t_los_off		100	us	From occurrence of presence of signal to negation of Rx_LOS

4.4.1 Module Power On Initialization Procedure, Tx_Disable Negated

During power on of the module, Tx_Fault, if implemented, may be asserted (high) as soon as power supply voltages are within specification. For module initialization with Tx_Disable negated, Tx_Fault shall be negated when the transmitter safety circuitry, if implemented, has detected that the transmitter is operating in its normal state. If a transmitter fault has not occurred, Tx_Fault shall be negated within a period t_start_up from the time that VccT exceeds the specified minimum operating voltage (see SFF-8418 SFP+ Module Power Supply Requirements). If the

Tx_Fault remains asserted after t_{start_up} , the host shall determine whether the module is cooled by reading the status bit over 2-wire interface. If the module is not cooled, the host may assume that a transmission fault has occurred. If the module is cooled, the host may assume that a transmission fault has occurred if Tx_Fault remains asserted beyond $t_{start_up_cooled}$.

The power on initialization timing for a module with Tx_Disable negated is shown in Figure 4.

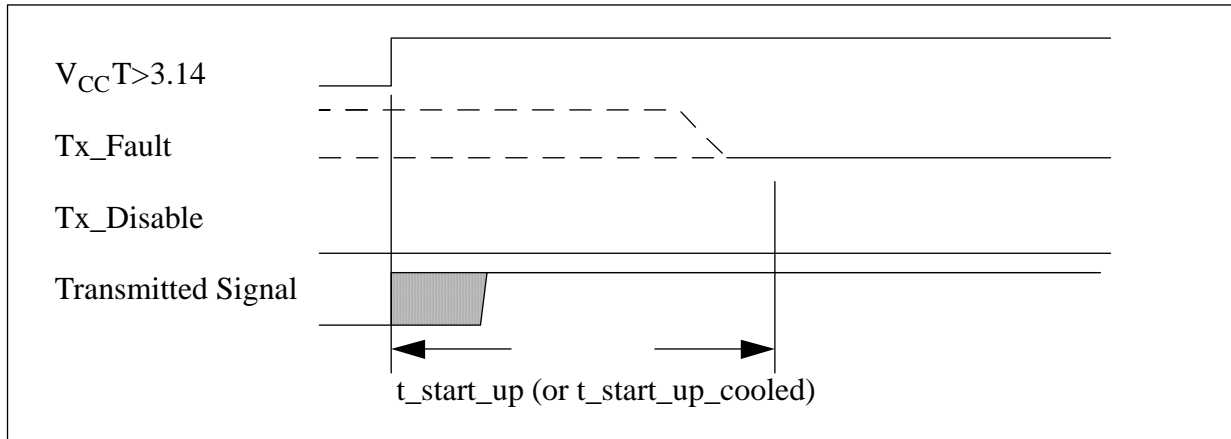


FIGURE 4 POWER ON INITIALIZATION OF MODULE, TX_DISABLE NEGATED

4.4.2 Module Power On Initialization Procedure, Tx_Disable Asserted.

For module power on initialization with Tx_Disable asserted, the state of Tx_Fault is not defined while Tx_Disable is asserted. After Tx_Disable is negated, Tx_Fault may be asserted while safety circuit initialization is performed. Tx_Fault shall be negated when the transmitter safety circuitry, if implemented, has detected that the transmitter is operating in its normal state. If a transmitter fault has not occurred, Tx_Fault shall be negated within a period t_{start_up} from the time that Tx_Disable is negated. If Tx_Fault remains asserted beyond the period t_{start_up} , the host may assume that a transmission fault has been detected by the module.

If no transmitter safety circuitry is implemented, the Tx_Fault signal may be tied to its negated state.

The power on initialization timing for a module with Tx_Disable asserted is shown in Figure 5.

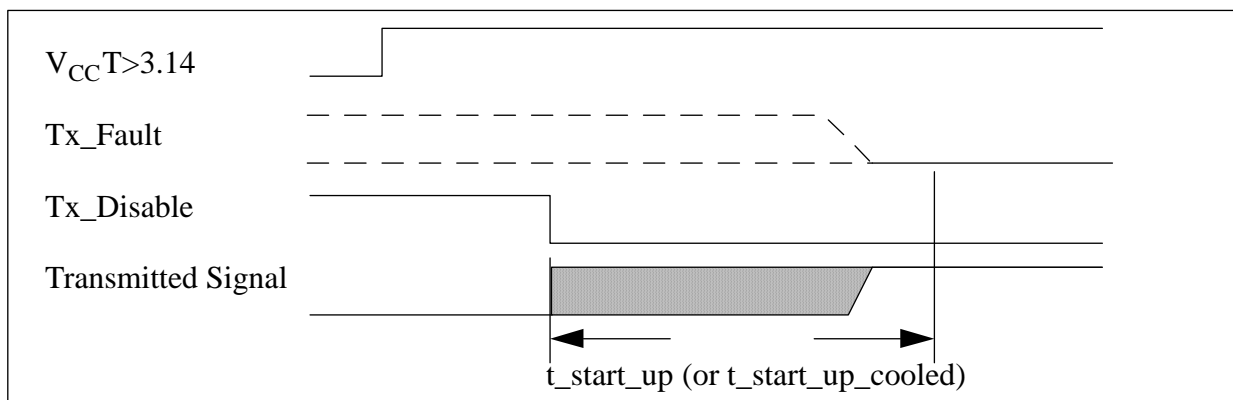


FIGURE 5 POWER ON INITIALIZATION OF MODULE, TX_DISABLE ASSERTED

4.4.3 Initialization During Hot Plugging

When a module is not installed, Tx_Fault is held to the asserted state by the pull up circuits on the host. As the module is installed, contact is made with the ground, voltage, and signal contacts in the specified order. After the module has determined that VccT has reached the specified value, the power on initialization takes place as described in the previous section. An example of initialization during hot plugging is provided in Figure 6.

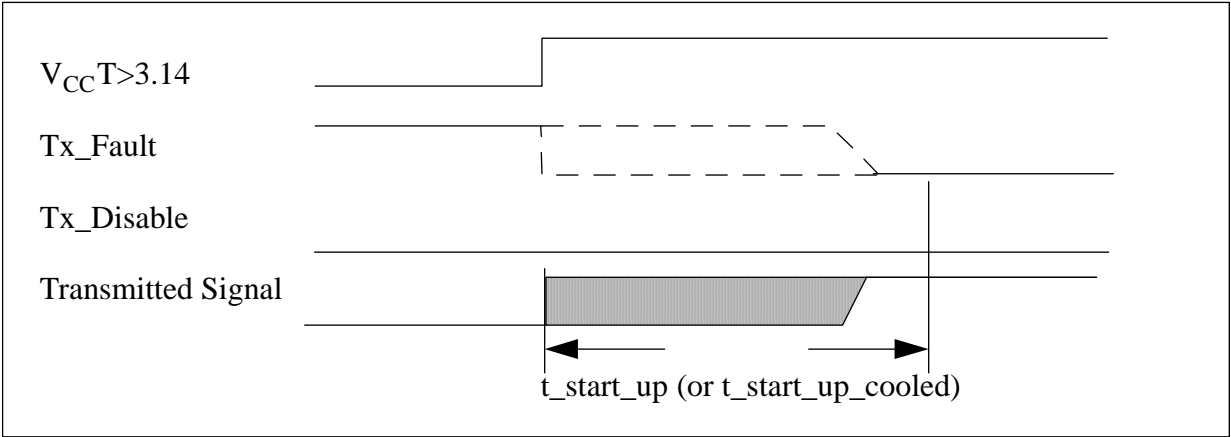


FIGURE 6 EXAMPLE OF INITIALIZATION DURING HOT PLUGGING, TX_DISABLE NEGATED

4.4.4 Transmitter Management

The timing requirements for the management of optical outputs from the module using the Tx_Disable signal are shown in Figure 7. Note that t_{on} time refers to the maximum delay until the modulated optical signal reaches 90% of the final value, not just the average optical power.

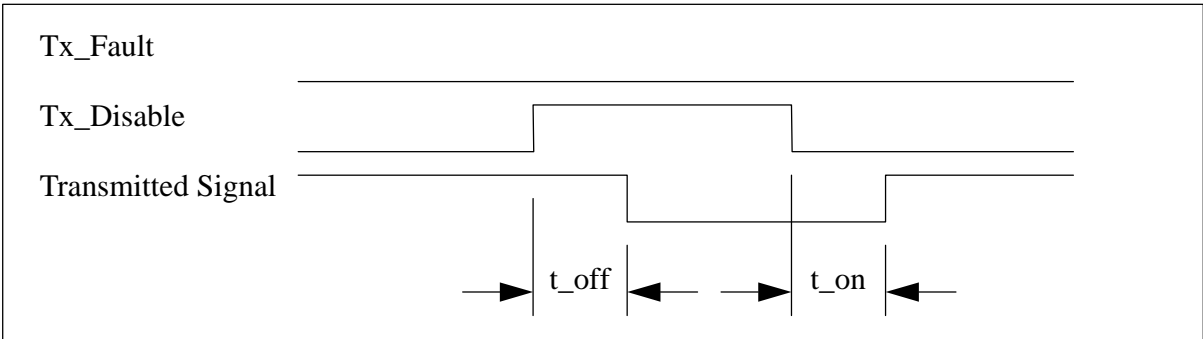


FIGURE 7 MANAGEMENT OF MODULE DURING NORMAL OPERATION, TX_DISABLE IMPLEMENTED

4.4.5 Transmitter Safety Detection and Presentation

If Tx_Fault is implemented it shall meet the timing requirements of Figure 8.

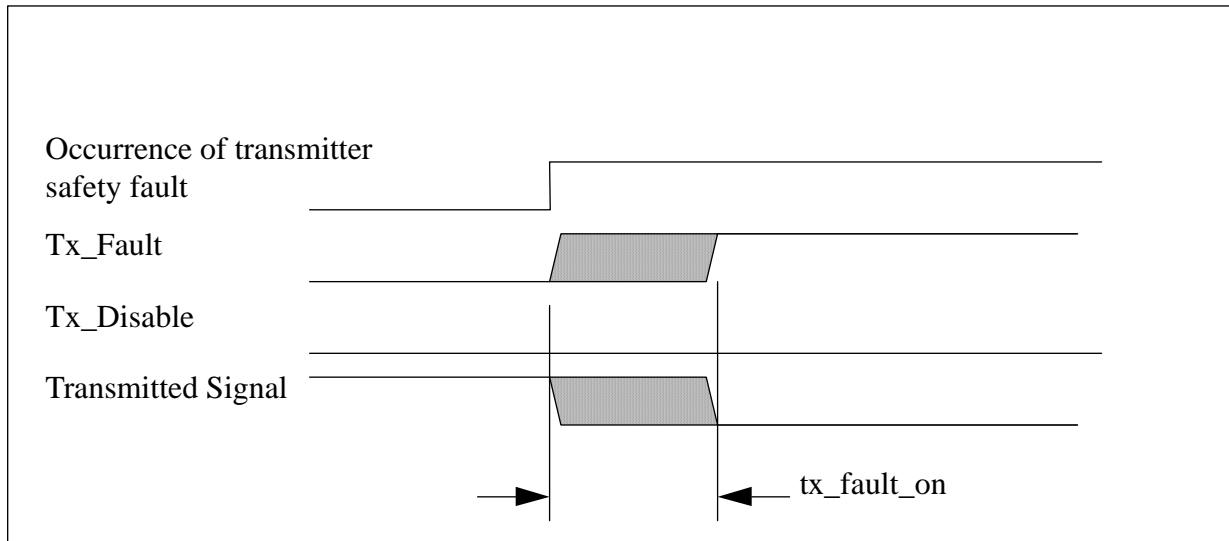


FIGURE 8 OCCURRENCE OF CONDITION GENERATING TX_FAULT

4.4.6 Module Fault Recovery

The detection of a safety-related transmitter fault condition presented by Tx_Fault shall be latched. The following protocol may be used to reset the latch in case the transmitter fault condition is transient.

To reset the fault condition and associated detection circuitry, Tx_Disable shall be asserted for a minimum of t_{reset} . Tx_Disable shall then be negated. Alternatively the Software Tx disable is asserted and negated. In less than the maximum value of $t_{\text{start_up}}$ the optical transmitter will correctly reinitialize the laser circuits, negate Tx_Fault, and begin normal operation if the fault condition is no longer present.

If a fault condition is detected during the reinitialization, Tx_Fault shall again be asserted, the fault condition again latched, and the optical transmitter circuitry will again be disabled until the next time a reset protocol is attempted. The manufacturer of the module shall ensure that the optical power emitted from an open connector or fiber is compliant with applicable eye safety requirements during all reset attempts, during normal operation or upon the occurrence of reasonable single fault conditions.

The module may require internal protective circuitry to prevent the frequent assertion of the Tx_Disable signal from generating frequent pulses of energy that violate the safety requirements. Timing for successful recovery from a transient safety fault condition is shown in Figure 9.

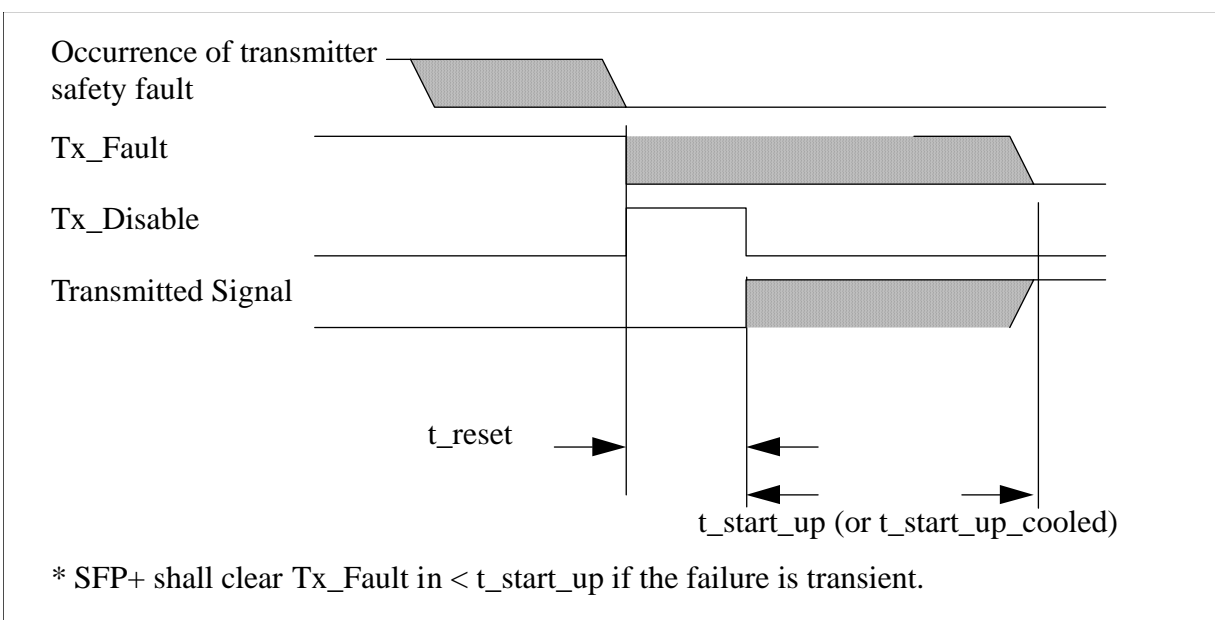


FIGURE 9 SUCCESSFUL RECOVERY FROM TRANSIENT SAFETY FAULT CONDITION

An example of an unsuccessful recovery, where the fault condition was not transient is shown in Figure 10.

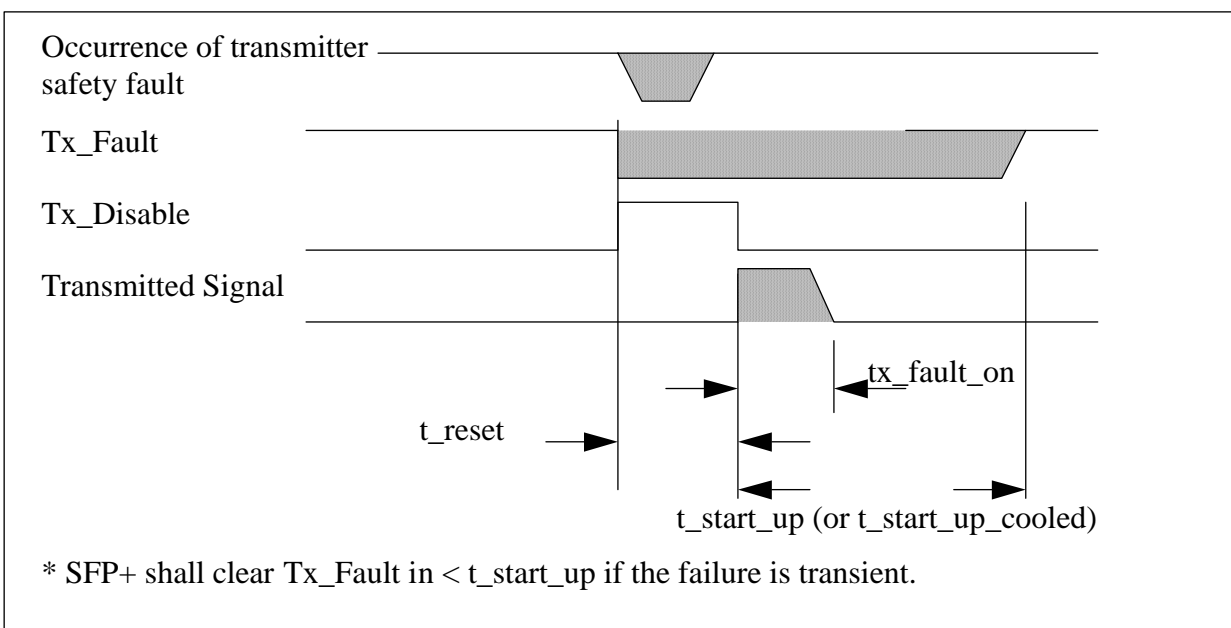


FIGURE 10 UNSUCCESSFUL RECOVERY FROM SAFETY FAULT CONDITION

4.4.7 Module Loss of Signal Indication

If the module is specified as implementing Rx_LOS, the timing is specified in Figure 11.

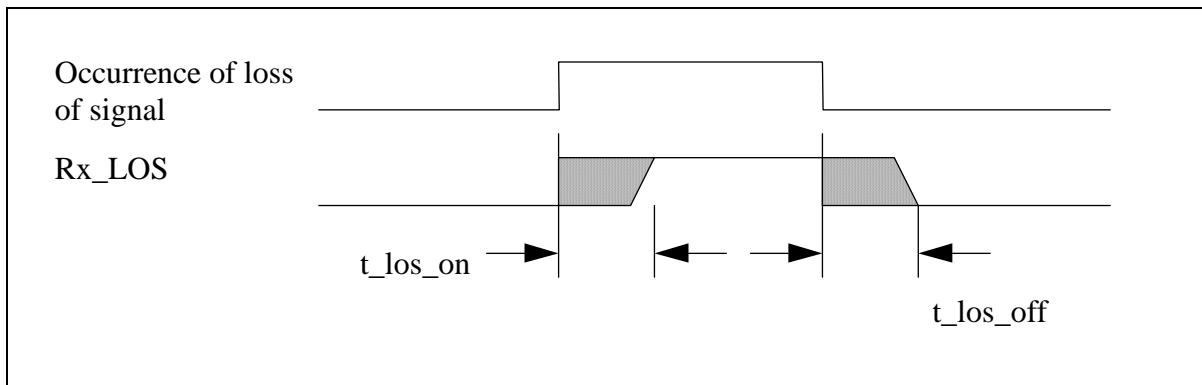


FIGURE 11 TIMING OF RX_LOS DETECTION

5. SFP+ 2-Wire Interface

5.1 Introduction

The SFP+ management interface is a two-wire interface, similar to I2C. SFP+ management memory map is specified by SFF-8472. Nomenclature for all registers more than 1 bit long are MSB...LSB (MSB transmitted first).

5.2 2-Wire Interface Electrical Specifications

The SFP+ 2-wire interface specifications are given in Table 7. These specifications ensure compatibility between host masters and SFP+ SCL/SDA lines and compatibility with I2C. All voltages are referenced to VeeT.

TABLE 7 2-WIRE INTERFACE ELECTRICAL SPECIFICATIONS

Parameter	Symbol	Max	Max	Unit	Conditions
Host 2-wire Vcc	Vcc_Host_2w	3.14	3.46	V	*1
SCL and SDA	VOL	0.0	0.40	V	Rp2w 2 pulled to Vcc_Host_2w, *3
	VOH	Vcc_Host_2w - 0.5	Vcc_Host_2w + 0.3	V	Rp2w 2 pulled to Vcc_Host_2w, *3
SCL and SDA	VIL	-0.3	VccT * 0.3	V	*3
	VIH	VccT * 0.7	VccT + 0.5	V	*3
Input current on the SCL and SDA contacts	II	-10	10	uA	
Capacitance on SCL and SDA I/O contact	Ci 4		14	pF	
Total bus capacitance for SCL and for SDA	Cb 5		100	pF	At 400 kHz, 3.0 kOhms Rp2w, max At 100 kHz, 8.0 kOhms Rp2w, max
			290	pF	At 400 kHz, 1.1 kOhms Rp2w, max At 100 kHz, 2.75 kOhms Rp2w, max

*1 The Host 2-wire Vcc is the voltage used for resistive pull ups for the 2 wire interface

*2 Rp2w is the pull up resistor. Active bus termination may be used by the host in place of a pullup resistor. Pull ups can be connected to any one of several power supplies, however the host board design shall ensure that no module contact has voltage exceeding module VccT/R + 0.5 V nor requires the module to sink more than 3.0 mA current.

*3 These voltages are measured on the other side of the connector to the device under test.

*4 Ci is the capacitance looking into the module SCL and SDA contacts

*5 Cb is the total bus capacitance on the SCL or SDA bus.

5.3 SFP+ 2-Wire Timing Diagram

SFP+ 2-wire bus timing is shown in Figure 12 and the detail of clock stretching is shown in Figure 13. SFP+ 2-wire timing specifications are given in Table 8.

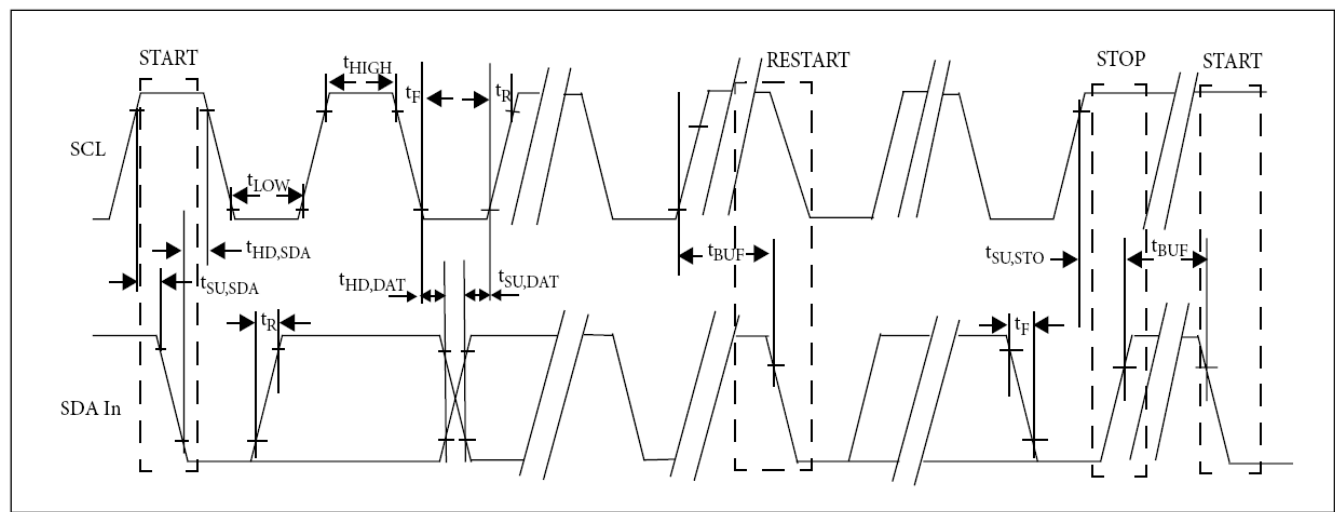


FIGURE 12 2-WIRE TIMING DIAGRAM

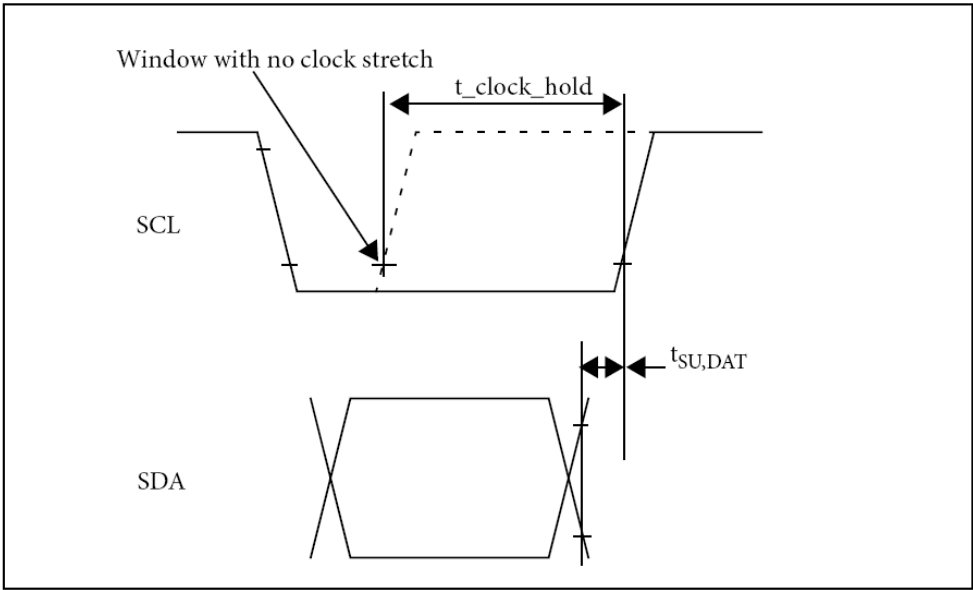


FIGURE 13 DETAIL OF CLOCK STRETCHING

The 2-wire serial interface addresses of the SFP+ module are 1010000x (A0h) and 1010001x (A2h).

TABLE 8 SFP+ 2-WIRE TIMING SPECIFICATIONS

Parameter	Symbol	Max	Max	Unit	Conditions
Clock Frequency	fSCL	0	400	kHz	Module shall operate with fSCL up to 100 kHz without requiring clock stretching. The module may clock stretch with fSCL greater than 100 kHz and up to 400 kHz.
Clock Pulse Width Low	tLOW	1.3		us	
Clock Pulse Width High	tHIGH	0.6		us	
Time bus free before new transmission can start	tBUF	20		us	Between STOP and START and between ACK and ReSTART
START Hold Time	tHD,STA	0.6		us	
START Set-up Time	tSU,STA	0.6		us	
Data In Hold Time	tHD,DAT	0		us	
Data In Set-up Time	tSU,DAT	0.1		us	
Input Rise Time (100 kHz)	tR,100		1000	ns	From (VIL,MAX - 0.15) to (VIH,MIN + 0.15)
Input Rise Time (400 kHz)	tR,400		300	ns	From (VIL,MAX - 0.15) to (VIH,MIN + 0.15)
Input Fall Time (100 kHz)	tF,100		300	ns	From (VIH,MIN + 0.15) to (VIL,MAX - 0.15)
Input Fall Time (400 kHz)	tF,400		300	ns	From (VIH,MIN + 0.15) to (VIL,MAX - 0.15)
STOP Set-up Time	tSU,STO	0.6		us	

5.4 Memory Transaction Timing

SFP+ memory transaction timings are given in Table 9.

TABLE 9 SFP+ MEMORY SPECIFICATIONS

Parameter	Symbol	Max	Max	Unit	Conditions
Serial Interface Clock Holdoff 'Clock Stretching'	T_clock_hold		500	us	Maximum time the SFP+ module may hold the SCL line low before continuing with a read or write operation
Complete Single or Sequential Write up to 4 Byte	tWR		40	ms	
Complete Sequential Write of 5-8 Byte	tWR		80	ms	
Endurance (Write Cycles)		10k		cycles	

5.5 Device Addressing and Operation

Serial Clock (SCL) The host supplied SCL input to SFP+ transceivers is used to positively edge clock data into each SFP+ device and negative edge clock data out of each device. The SCL line may be pulled low by an SFP+ module during clock stretching.

Serial Data (SDA) The SDA contact is bi-directional for serial data transfer. This contact is open-drain or open-collector driven and may be wire-ORed with other open-drain or open collector devices with different device addresses, provided the total bus capacitance

	meets the requirement of Table 7 and the Serial Clock (SCL) is also wire-ORed.
Master/Slave	SFP+ transceivers operate only as slave devices. The host must provide a bus master for SCL and initiate all read/write communication.
Device Address	Each SFP+ is hard wired at the device addresses A0h and A2h. See SFF-8472 for memory structure within each transceiver.
Clock and Data Transitions	The SDA contact is normally pulled high with an external device. Data on the SDA contact may change only during SCL low time periods. Data changes during SCL high periods indicate a START or STOP condition. All addresses and data words are serially transmitted to and from the SFP+ in 8-bit words. Every byte on the SDA line must be 8-bits long. Data is transferred with the most significant bit (MSB) first.
START Condition	A high-to-low transition of SDA with SCL high is a START condition, which must precede any other command.
STOP Condition	A low-to-high transition of SDA with SCL high is a STOP condition.
Acknowledge	After sending each 8-bit word, the transmitter releases the SDA line for one bit time, during which the receiver is allowed to pull SDA low (zero) to acknowledge (ACK) that it has received each word. Device address bytes and write data bytes initiated by the host shall be acknowledged by SFP+ transceivers. Read data bytes transmitted by SFP+ transceivers shall be acknowledged by the host for all but the final byte read, for which the host shall respond with a STOP instead of an ACK.
Non-acknowledge (NACK)	When a slave is unable to receive or transmit, because, e.g., it is performing a higher priority function, the data line shall be left high by the slave. A NACK is generated when the slave leaves the data line high during the ACK clock pulse. The master can then generate either a STOP condition to abort the transfer or a repeated START condition to start a new transfer.
	When in a transfer, a master-receiver must signal the end of data to the slave-transmitter by not generating an acknowledge on the last byte clocked out of the slave. A NACK is generated when the master leaves the data line High during the ACK clock pulse. The slave-transmitter must release the data line to permit the master to generate a STOP or repeated START condition.
Memory (Management Interface) Reset	After an interruption in protocol, power loss or system reset the SFP+ management interface can be reset. Memory reset is intended only to reset the SFP+ transceiver management interface (to correct a hung bus). No other transceiver functionality is implied. <ol style="list-style-type: none"> 1. Clock up to 9 cycles. 2. Look for SDA high in each cycle while SCL is high. 3. Create a START condition as SDA is high.
Device Addressing	SFP+ devices require an 8 bit device address word following a start condition to enable a read or write operation. The device addresses to select A0h or A2h are shown in Table 10. This is common to all SFP+ devices.

TABLE 10 SFP+ DEVICE ADDRESS WORD

Address							Address Select	R/W select
A0h	1	0	1	0	0	0	0	x
A2h	1	0	1	0	0	0	1	x
	MSB							LSB
The LSB of the device address word is the read/write operating select bit. A read operation is initiated if this bit is set high and a write operation is initiated if this bit is set low.								

5.6 Read/Write Functionality

The methods for reading from and writing to the two different SFP+ addresses A0h and A2h are described in this section. They are identical for the two different addresses except that the appropriate address is used for each read and write. For simplicity in the figures the address is labelled 101000x where the x is 0 for the A0h address and 1 for the A2h address. Note that the address here is only seven bits. In order to complete the full 8 bit byte a one or zero is added to the end of the address depending on whether a read or a write operation is taking place.

5.6.1 Memory Address Counter (Read and Write Operations)

SFP+ devices maintain two internal data word address counters one for each address. These counters contain the last address accessed during the latest read or write operation, incremented by one. The address counter is incremented whenever a data word is received or sent by the transceiver. This address stays valid between operations as long as SFP+ power is maintained. The address 'roll over' during read and write operations is from the last byte of the 256 byte memory page to the first byte of the same page.

5.6.2 Read Operations (Current Address Read)

A current address read operation requires only that the device address read word (10100001 or 10100011) be sent, Figure 14. Once acknowledged by the SFP+, the current address data word is serially clocked out. The host does not respond with an acknowledge, but does generate a STOP condition once the data word is read.

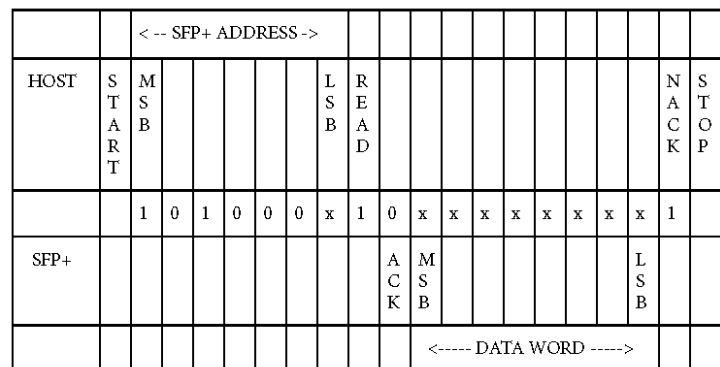


FIGURE 14 CURRENT ADDRESS READ OPERATION

5.6.3 Read Operations (Random Read)

A random read operation requires a 'dummy' write operation to load in the target byte address Figure 15. This is accomplished by the following sequence: The target 8-bit data word address is sent following the device address write word (10100000 or 10100010) and acknowledged by the SFP+. The host then generates another START condition (aborting the dummy write without incrementing the counter) and a current address read by sending a device read address (10100001 or 10100011). The SFP+ acknowledges the device address and serially clocks out the requested data word.

The host does not respond with an acknowledge, but does generate a STOP condition once the data word is read.

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FIGURE 15 RANDOM READ

5.6.4 Read Operations (Sequential Read)

Sequential reads are initiated by either a current word address read Figure 16 or a random address read Figure 17. To specify a sequential read, the host responds with an acknowledge (instead of a STOP) after each data word. As long as the SFP+ receives an acknowledge, it shall serially clock out sequential data words. The sequence is terminated when the host responds with a NACK and a STOP instead of an acknowledge.

[illegible]

FIGURE 16 SEQUENTIAL ADDRESS READ STARTING AT CURRENT WORD ADDRESS

[illegible]

FIGURE 17 SEQUENTIAL ADDRESS READ STARTING WITH RANDOM READ

5.6.5 Write Operations (Byte Write)

A write operation requires an 8-bit data word address following the device address

write word (10100000 or 10100010) and acknowledgement Figure 18. Upon receipt of this address, the SFP+ shall again respond with a zero (ACK) to acknowledge and then clock in the first 8 bit data word. Following the receipt of the 8 bit data word, the SFP+ shall output a zero (ACK) and the host master must terminate the write sequence with a STOP condition for the write cycle to begin. If a START condition is sent in place of a STOP condition (i.e. a repeated START per the I2C specification) the write is aborted and the data received during that operation is discarded. Upon receipt of the proper STOP condition, the SFP+ enters an internally timed write cycle, t_{WR} , to internal memory. The SFP+ disables its management interface input during this write cycle and shall not respond or acknowledge subsequent commands until the write is complete. Note that I2C 'Combined Format' using repeated START conditions is not supported on SFP+ write commands.

[illegible]

FIGURE 18 SFP+ WRITE BYTE OPERATION

5.6.6 Write Operations (Sequential Write)

SFP+ shall support up to an 8 sequential byte write without repeatedly sending SFP+ address and memory address information. A 'sequential' write is initiated the same way as a single byte write, but the host master does not send a stop condition after the first word is clocked in. Instead, after the SFP+ acknowledges receipt of the first data word, the host can transmit up to seven more data words. The SFP+ shall send an acknowledge after each data word received. The host must terminate the sequential write sequence with a STOP condition or the write operation shall be aborted and data discarded. Note that I2C 'combined format' using repeated START conditions is not supported on SFP+ write commands.

[illegible]

FIGURE 19 SEQUENTIAL WRITE OPERATION

5.6.7 Write Operations (Acknowledge Polling)

Once the SFP+ internally timed write cycle has begun (and inputs are being ignored on the bus) acknowledge polling can be used to determine when the write operation is complete. This involves sending a START condition followed by the device address

word. Only if the internal write cycle is complete shall the SFP+ respond with an acknowledge to subsequent commands, indicating read or write operations can continue.

A. Test Methodology And Measurement (Normative)

A.1 Power Supply Testing Methodology

This section defines power supply noise output as given in 2.1.2 and 2.1.3, and power supply noise tolerance as in 2.1.4.

The reference power supply filter shown in Figure 20 is provided for module testing, including power supply tolerance testing. This filter will meet the noise filtering requirements in most host systems. Other filtering implementations or local regulation may be used to meet the power noise output requirements described in 2.1.2 and 2.1.3.

For each Vcc, the sum of the equivalent series resistances of the 4.7uH inductor, the 22uF capacitor and the damping resistor is 0.5 Ohms. This resistance is desirable in actual host filters as well as in the reference filter; however, any voltage drop across a filter network on the host is counted against the host VccT and VccR accuracy specification in Table 1.

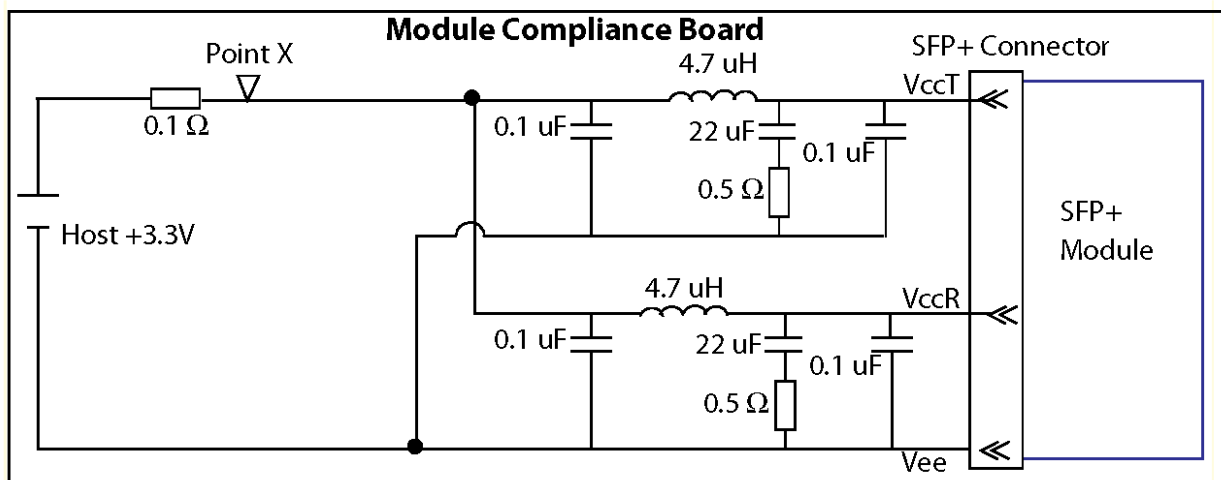


FIGURE 20 MODULE COMPLIANCE BOARD POWER SUPPLY FILTERS

A.1.1 Host Power Supply Noise Output

The noise output of a Vcc supply of a host is defined with a resistive load that draws the maximum rated power (1 W or 1.5 W) connected between one Vcc contact and Vee, in place of the SFP+ module. When the noise on VccT is being measured, VccR is left open circuit, and vice versa. 8 Ohms is used for a host capable of supporting Power Level II, and 12 Ohms otherwise. The AC voltage spectrum is measured at the module side of the SFP+ connector. The noise power spectrum is divided by the truncated response of the reference filter and then integrated from 10 Hz to 10 MHz and converted to a voltage. This function is illustrated in the equation below and Figure 21. The specification limit is given in 2.1.2. The test is performed with all other portions of the host board/system active. Hosts with multiple SFP+ modules shall test ports one at a time, with active SFP+ in all the remaining ports.

$$H(f) = a \times (\log_{10}(f))^4 + b \times (\log_{10}(f))^3 + c \times (\log_{10}(f))^2 + d \times (\log_{10}(f)) + e$$

The reference filter response $H(f)$ shown in Figure 21 and the coefficients a , b , c , d , and e for the 5 frequency bands are defined in Table 11.

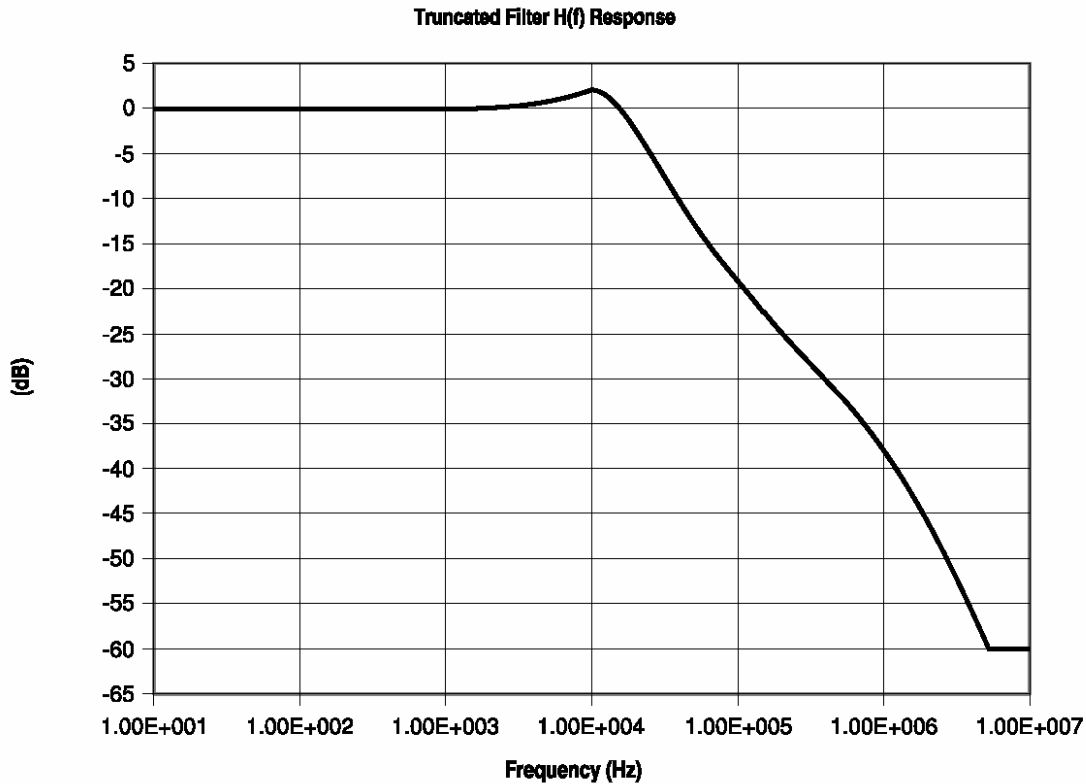


FIGURE 21 REFERENCE FILTER RESPONSE

TABLE 11 TRUNCATED FILTER RESPONSE COEFFICIENTS

Frequency (f)	a	b	c	d	e
10 Hz ≤ f < 100 Hz	0	0	0	0	-0.1
100 Hz ≤ f < 10 kHz	0.3784	-3.6045	12.694	-19.556	11.002
10 kHz ≤ f < 150 kHz	-22.67038	430.392	-3053.779	9574.26	-11175.98
150 kHz ≤ f ≤ 5.243 MHz	3.692166	91.467	838.80	-3400.38	5139.285
5.243 MHz ≤ f ≤ 10 MHz	0	0	0	0	-60

NOTES: As a lightly loaded power supply might generate more noise than a fully loaded supply, the host implementer may wish to assess the host power supply noise output at less than maximum current draw also. Because a small measured noise signal at high frequencies is multiplied up to give the inferred noise at virtual point X, care should be taken over the noise floor of the spectrum analyzer. Other measurement methods could be used, e.g. a measurement at a point inside the host, with appropriate consideration to any difference between the reference filter and a host's actual filter.

A.1.2 SFP+ Module Power Supply Noise Output

The module noise voltage output is defined in the frequency band 10 Hz to 10 MHz at point X in Figure 20.

The module must pass module power supply noise output test in all operating modes. This test ensures the module will not couple excessive noise from inside the module back onto the host board. A power meter technique, or a spectrum analyzer technique with integration of the spectrum, may be used. The maximum allowed noise amplitude

is given in 2.1.3.

A.1.3 Module Power Supply Tolerance Testing

In this test, a swept sinusoidal tone is applied at point X of Figure 22 with the tolerance signal amplitude and frequency range given in 2.1.4. The AC tolerance signal is created by a circuit such as a low impedance buffer amplifier between the power supply and point X. The impedance of the PSU and sine wave generator is less than 0.5 Ohms. The amplitude of the sine wave is calibrated at each frequency at point X with the module replaced with a 12 Ohms load between Vcc and Vee.

NOTES -- It may be desirable to remove the 0.1 uF capacitors on the host side of the reference filters for this test, to reduce the power needed by the sine wave generator. The calibration of the sine wave is not expected to be significantly different if the module were in place rather than the test resistor.

Alternatively, the test may be performed separately for VccT and VccR with the other supply filter connected directly to the power supply. It is not necessary to show compliance with both separate and common Vcc modulation.

This test applies at minimum and maximum DC setpoint levels. Note that the DC level is inset to the limits in SFF-8419 Low Speed Module Electrical Specifications by the peak of the sinusoidal voltage at the input to the module (which is frequency dependent).

The source frequency is varied over the range specified by 2.1.4 to determine if any frequency causes a parameter to fall out of the specification limit. In all cases, the parameters measured shall pass the optical standards with the tone present over all frequencies specified. Parameters of interest for the transmit may include UJ, Qsq and TDP see [IEEE 802.3]. For the receive side, they include stressed sensitivity, overload, RN and Rx_LOS function.

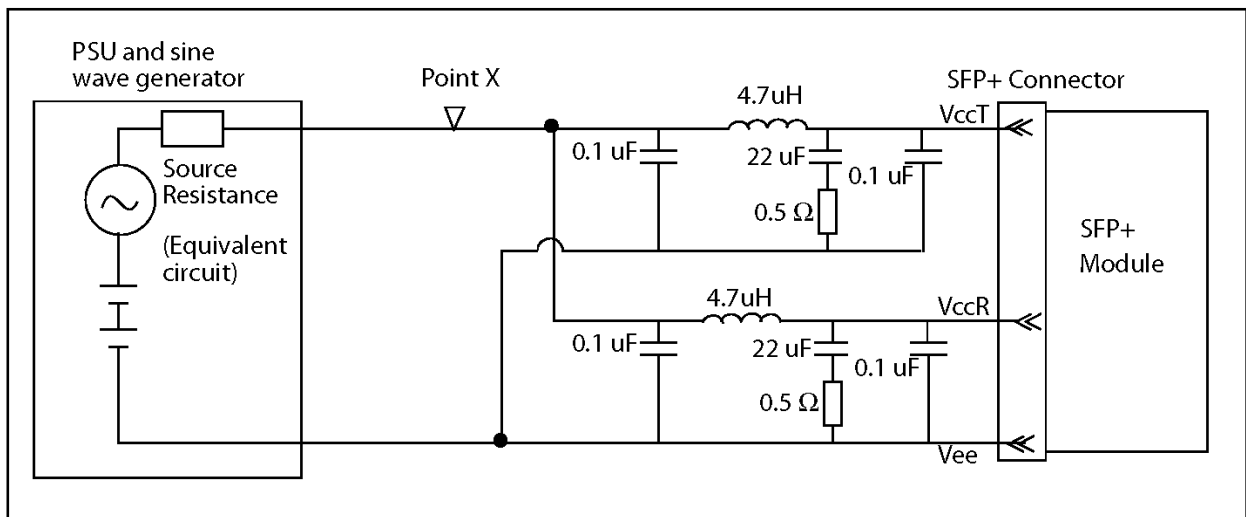


FIGURE 22 POWER SUPPLY NOISE TOLERANCE TEST SETUP

The AC voltage at node X is defined with reference to Vee. The DC voltage specification including ripple, droop and noise below 100 kHz is met at both VccT and VccR (at the SFP+ connector).